

<b>Notice of References Cited</b>	Application/Control No. 09/841,912	Applicant(s)/Patent Under Reexamination SMITH ET AL.	
	Examiner Russell Frejd	Art Unit 2128	Page 1 of 1

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	B	US-			
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	D	US-			
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	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.